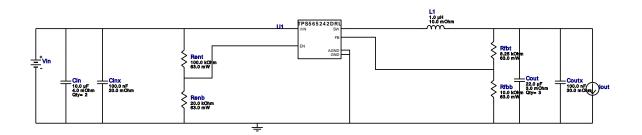


WEBENCH® Design Report

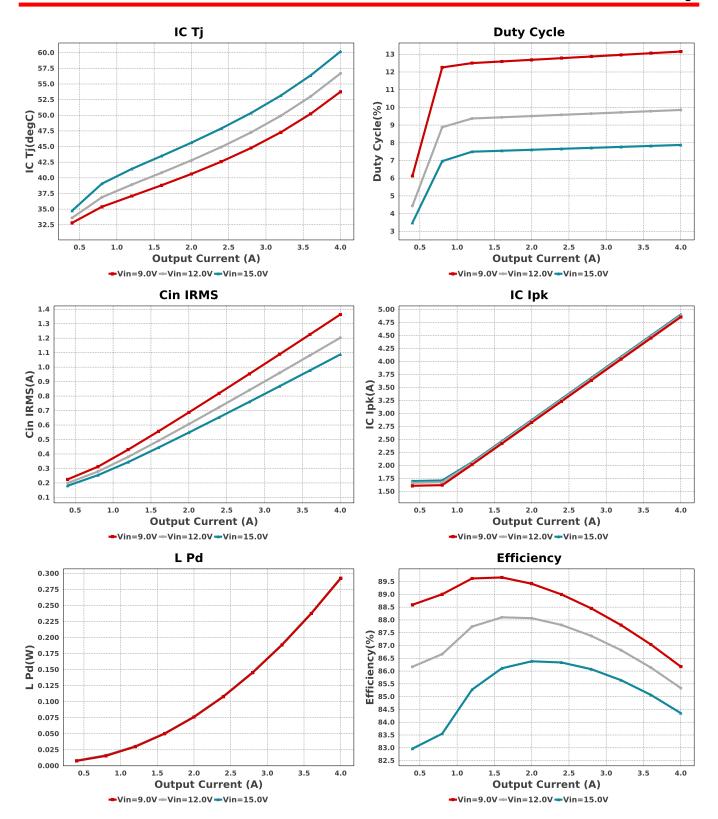
VinMin = 9.0V VinMax = 15.0V Vout = 1.1V Iout = 4.0A Device = TPS565242DRLR Topology = Buck Created = 2025-04-12 12:08:17.303 BOM Cost = \$0.93 BOM Count = 13 Total Pd = 0.82W

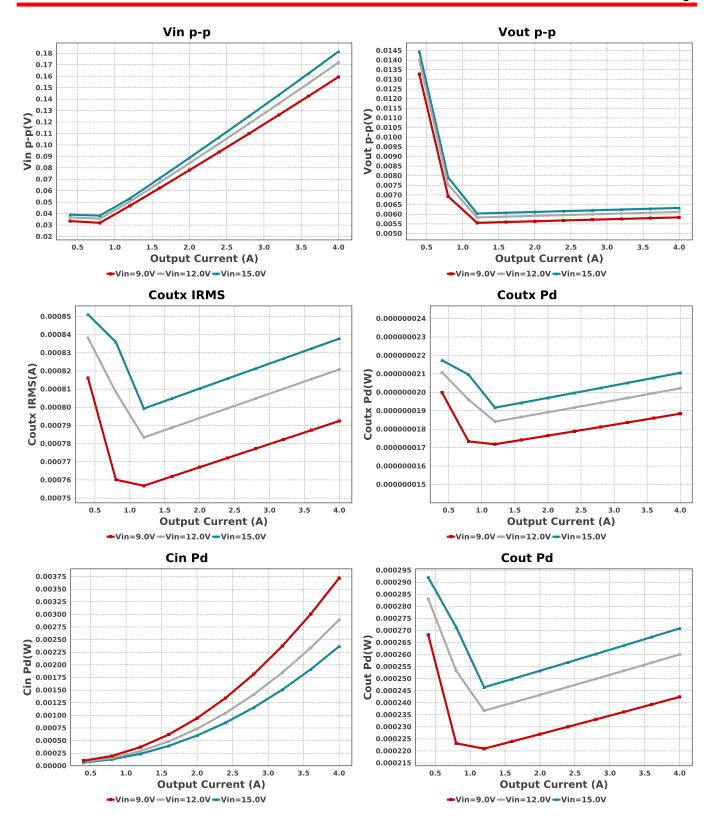
Design: 10 TPS565242DRLR TPS565242DRLR 9V-15V to 1.10V @ 4A

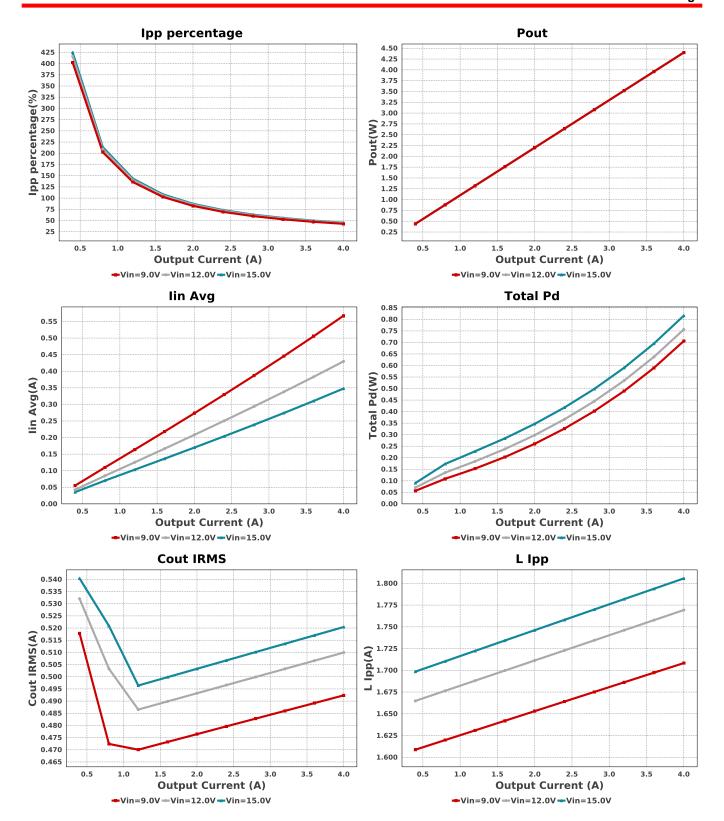


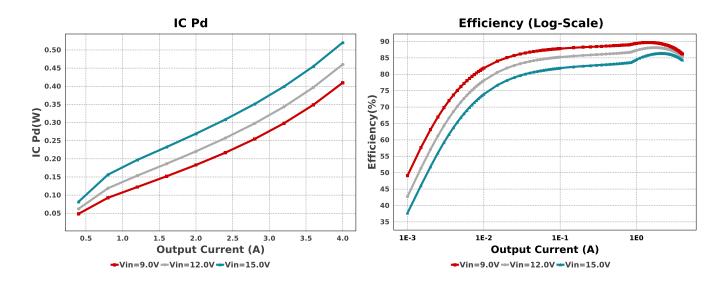
Electrical BOM

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cin	MuRata	GRM21BR61E106MA73L Series= X5R	Cap= 10.0 uF ESR= 4.0 mOhm VDC= 25.0 V IRMS= 2.8 A	2	\$0.04	0805 7 mm ²
Cinx	MuRata	GRM188R71H104KA93D Series= X7R	Cap= 100.0 nF ESR= 20.0 mOhm VDC= 50.0 V IRMS= 3.8 A	1	\$0.02	0603 5 mm ²
Cout	MuRata	GRM21BR61A226ME44L Series= X5R	Cap= 22.0 uF ESR= 3.0 mOhm VDC= 10.0 V IRMS= 3.84 A	3	\$0.09	0805 7 mm ²
Coutx	MuRata	GRM188R71E104KA01D Series= X7R	Cap= 100.0 nF ESR= 30.0 mOhm VDC= 25.0 V IRMS= 1.51 A	1	\$0.01	0603 5 mm ²
L1	Bourns	SRN8040-1R0Y	L= 1.0 μH 10.0 mOhm	1	\$0.33	SRN8040 100 mm ²
Renb	Vishay-Dale	CRCW040220K0FKED Series= CRCWe3	Res= 20.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
Rent	Vishay-Dale	CRCW0402100KFKED Series= CRCWe3	Res= 100.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
Rfbb	Vishay-Dale	CRCW040210K0FKED Series= CRCWe3	Res= 10.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
Rfbt	Vishay-Dale	CRCW04028K25FKED Series= CRCWe3	Res= 8.25 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
U1	Texas Instruments	TPS565242DRLR	Switcher	1	\$0.18	DRL0006A 7 mm²









Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	1.087 A	Capacitor	Input capacitor RMS ripple current
2.	Cin Pd	2.365 mW	Capacitor	Input capacitor power dissipation
3.	Cout IRMS	520.418 mA	Capacitor	Output capacitor RMS ripple current
4.	Cout Pd	270.83 μW	Capacitor	Output capacitor power dissipation
5.	Coutx IRMS	837.803 μA	Capacitor	Output capacitor_x RMS ripple current
6.	Coutx Pd	21.057 nW	Capacitor	Output capacitor_x power loss
7.	IC lpk	4.903 A	IC .	Peak switch current in IC
8.	IC Pd	520.42 mW	IC	IC power dissipation
9.	IC Ti	60.184 degC	IC	IC junction temperature
10.	IC Tolerance	11.0 mV	IC	IC Feedback Tolerance
11.	ICThetaJA Effective	58.0 degC/W	IC	IC junction-to-ambient thermal resistance with TI EVM
12.	lin Avg	347.73 mA	IC	Average input current
13.	lpp percentage	45.142 %	Inductor	Inductor ripple current percentage (with respect to average inductor
				current)
	L lpp	1.806 A	Inductor	Peak-to-peak inductor ripple current
	L Pd	292.89 mW	Inductor	Inductor power dissipation
	Cin Pd	2.365 mW	Power	Input capacitor power dissipation
	Cout Pd	270.83 μW	Power	Output capacitor power dissipation
_	Coutx Pd	21.057 nW	Power	Output capacitor_x power loss
19.	IC Pd	520.42 mW	Power	IC power dissipation
	L Pd	292.89 mW	Power	Inductor power dissipation
21.	Total Pd	815.983 mW	Power	Total Power Dissipation
22.	BOM Count	13	System	Total Design BOM count
			Information	
23.	Duty Cycle	7.878 %	System Information	Duty cycle
24.	Efficiency	84.356 %	System	Steady state efficiency
		0 11000 70	Information	Cloudy dialo cinolono,
25.	FootPrint	162.0 mm ²	System	Total Foot Print Area of BOM components
			Information	
26.	Frequency	601.211 kHz	System	Switching frequency
			Information	
27.	lout	4.0 A	System	lout operating point
			Information	
28.	Mode	CCM	System	Conduction Mode
			Information	
29.	Pout	4.4 W	System	Total output power
			Information	T
30.	Total BOM	\$0.93	System	Total BOM Cost
31.	Vin	15.0 V	Information	Vin operating point
31.	VIII	15.0 V	System	Vin operating point
32.	Vin p-p	181.547 mV	Information System	Peak-to-peak input voltage
JZ.	viii p-p	101.547 1117	Information	i eak-to-peak input voltage
33.	Vout	1.1 V	System	Operational Output Voltage
55.	vout	1.1 V	Information	Operational Output Voltage
34.	Vout Actual	1.095 V	System	Vout Actual calculated based on selected voltage divider resistors
			Information	
35.	Vout Tolerance	2.763 %	System	Vout Tolerance based on IC Tolerance (no load) and voltage divider
			Information	resistors if applicable
36.	Vout p-p	6.327 mV	System	Peak-to-peak output ripple voltage
			Information	

Design Inputs

Name	Value	Description	
lout	4.0	Maximum Output Current	
VinMax	15.0	Maximum input voltage	
VinMin	9.0	Minimum input voltage	
Vout	1.1	Output Voltage	
base_pn	TPS565242	Base Product Number	
source	DC	Input Source Type	
Та	30.0	Ambient temperature	

WEBENCH® Assembly

Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of Cin and Cout, and the inductance and DC resistance of L1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

Soldering Component to Board

If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab town to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 9.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to Vin and GND. Connect a digital volt meter and a load if needed to set the minimum lout of the design from Vout and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between Vin and GND, a load is connected between Vout and GND and a current meter is connected in series between Vout and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.

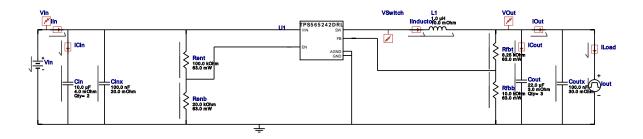


WEBENCH[®] Electrical Simulation Report

Design Id = 10

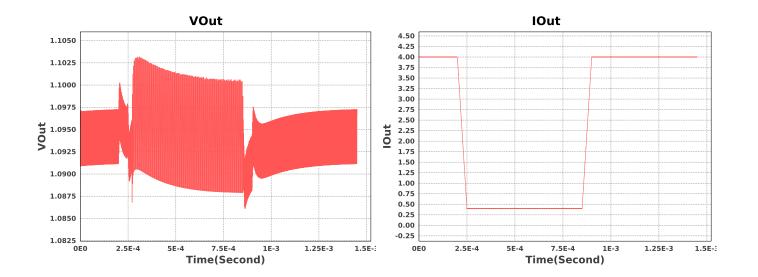
 $sim_id = 1$

Simulation Type = Load Transient



Simulation Parameters

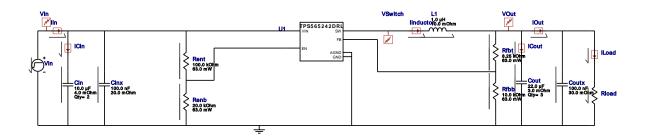
#	Name	Parameter Name	Description	Values
1.	L1	IC	Initial Current	4.0 A
2.	lout	signal_type I1 I2	Signal Type Initial Load Current Minimum Load Current	PULSE 4.0 A 0.4 A
		Td Tf Tr Pw	Initial Time Delay Fall Time Rise Time Pulse Width	200u s 50u s 50u s 600u s



Design Id = 10

 $sim_id = 2$

Simulation Type = Startup



Simulation Parameters

#	Name	Parameter Name	Description	Values
_				
1.	Rload	R	Load Resistance	0.275 Ohm

Design Assistance

- 1. Master key: 7184E8B77D068D1CE343DD0BE1E418A5[v1]
- 2. TPS565242 Product Folder: http://www.ti.com/product/TPS565242: contains the data sheet and other resources.

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